



Material Content Data Sheet



Sales Product Name		IKW60N60H3		Issued		4. October 2018		
MA#		MA003763038						
Package		PG-TO247-3-41		Weight*		6050.81 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	1.539	0.03	0.03	254	254
chip_2	inorganic material	silicon	7440-21-3	6.195	0.10	0.10	1024	1024
leadframe	inorganic material	phosphorus	7723-14-0	0.159	0.00		26	
	non noble metal	iron	7439-89-6	0.530	0.01		88	
	non noble metal	copper	7440-50-8	529.068	8.74	8.75	87438	87552
	non noble metal	aluminium	7429-90-5	15.087	0.25	0.25	2493	2493
wire	non noble metal	aluminium	7429-90-5	15.087	0.25	0.25	2493	2493
encapsulation	organic material	carbon black	1333-86-4	19.894	0.33		3288	
	plastics	epoxy resin	-	377.984	6.25		62468	
	inorganic material	silicondioxide	60676-86-0	1591.512	26.30	32.88	263024	328780
leadfinish	non noble metal	tin	7440-31-5	31.874	0.53	0.53	5268	5268
plating	non noble metal	nickel	7440-02-0	29.065	0.48	0.48	4803	4803
solder	non noble metal	antimony	7440-36-0	0.542	0.01		90	
	noble metal	silver	7440-22-4	1.355	0.02		224	
	non noble metal	tin	7440-31-5	3.522	0.06	0.09	582	896
heatspreader	inorganic material	phosphorus	7723-14-0	1.033	0.02		171	
	non noble metal	iron	7439-89-6	3.442	0.06		569	
	non noble metal	copper	7440-50-8	3438.006	56.81	56.89	568190	568930
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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